

Silicon Diffused Power Transistor

BU2708AF

GENERAL DESCRIPTION

High voltage, high speed switching npn transistor in a plastic full-pack envelope. Intended for use in horizontal deflection circuits of colour television receivers. Features exceptional tolerance to base drive and collector current load variations, resulting in a low worst-case dissipation. Designed to withstand V_{CES} pulses up to 1700 V.

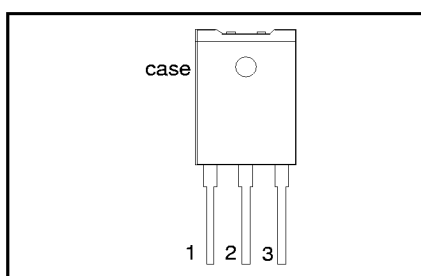
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V_{CESM}	Collector-emitter voltage peak value	$V_{BE} = 0$ V	-	1700	V
V_{CEO}	Collector-emitter voltage (open base)		-	825	V
I_C	Collector current (DC)		-	8	A
I_{CM}	Collector current peak value		-	15	A
P_{tot}	Total power dissipation	$T_{hs} \leq 25$ °C	-	45	W
V_{CESat}	Collector-emitter saturation voltage	$I_C = 4$ A; $I_B = 1.33$ A	-	1.0	V
I_{Csat}	Collector saturation current	$f = 16$ kHz	4	-	A
t_s	Storage time	$I_{Csat} = 4$ A; $f = 16$ kHz	4.8	5.5	μ s

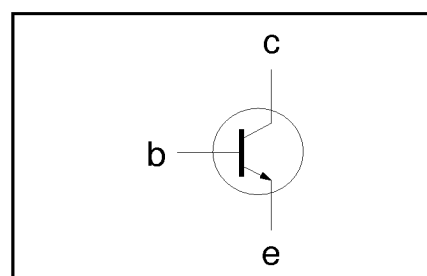
PINNING - SOT199

PIN	DESCRIPTION
1	base
2	collector
3	emitter
case	isolated

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CESM}	Collector-emitter voltage peak value	$V_{BE} = 0$ V	-	1700	V
V_{CEO}	Collector-emitter voltage (open base)		-	825	V
I_C	Collector current (DC)		-	8	A
I_{CM}	Collector current peak value		-	15	A
I_B	Base current (DC)		-	4	A
I_{BM}	Base current peak value		-	6	A
$-I_{BM}$	Reverse base current peak value ¹		-	5	A
P_{tot}	Total power dissipation	$T_{hs} \leq 25$ °C	-	45	W
T_{stg}	Storage temperature		-65	150	°C
T_j	Junction temperature		-	150	°C

ESD LIMITING VALUES

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_C	Electrostatic discharge capacitor voltage	Human body model (250 pF, 1.5 k Ω)	-	10	kV

¹ Turn-off current.

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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$R_{th\ j-hs}$	Junction to heatsink	without heatsink compound	-	3.7	K/W
$R_{th\ j-hs}$	Junction to heatsink	with heatsink compound	-	2.8	K/W
$R_{th\ j-a}$	Junction to ambient	in free air	35	-	K/W

ISOLATION LIMITING VALUE & CHARACTERISTIC

 $T_{hs} = 25\text{ °C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{isol}	Repetitive peak voltage from all three terminals to external heatsink	R.H. $\leq 65\%$; clean and dustfree	-		2500	V
C_{isol}	Capacitance from T2 to external heatsink	$f = 1\text{ MHz}$	-	22	-	pF

STATIC CHARACTERISTICS

 $T_{hs} = 25\text{ °C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CES}	Collector cut-off current ²	$V_{BE} = 0\text{ V}; V_{CE} = V_{CESMmax}$	-	-	1.0	mA
I_{CES}		$V_{BE} = 0\text{ V}; V_{CE} = V_{CESMmax}$ $T_j = 125\text{ °C}$	-	-	2.0	mA
I_{EBO}	Emitter cut-off current	$V_{EB} = 6\text{ V}; I_C = 0\text{ A}$	-	-	70	μA
BV_{EBO}	Emitter-base breakdown voltage	$I_B = 1\text{ mA}$	7.5	13.5	-	V
$V_{CEOsust}$	Collector-emitter sustaining voltage	$I_B = 0\text{ A}; I_C = 100\text{ mA};$ $L = 25\text{ mH}$	825	900	-	V
V_{CEsat}	Collector-emitter saturation voltage	$I_C = 4\text{ A}; I_B = 1.33\text{ A}$	-	-	1.0	V
V_{BEsat}	Base-emitter saturation voltage	$I_C = 4\text{ A}; I_B = 1.33\text{ A}$	0.83	0.91	1.00	V
h_{FE}	DC current gain	$I_C = 100\text{ mA}; V_{CE} = 5\text{ V}$	-	21	-	
h_{FE}		$I_C = 4\text{ A}; V_{CE} = 1\text{ V}$	3	6	7.3	

DYNAMIC CHARACTERISTICS

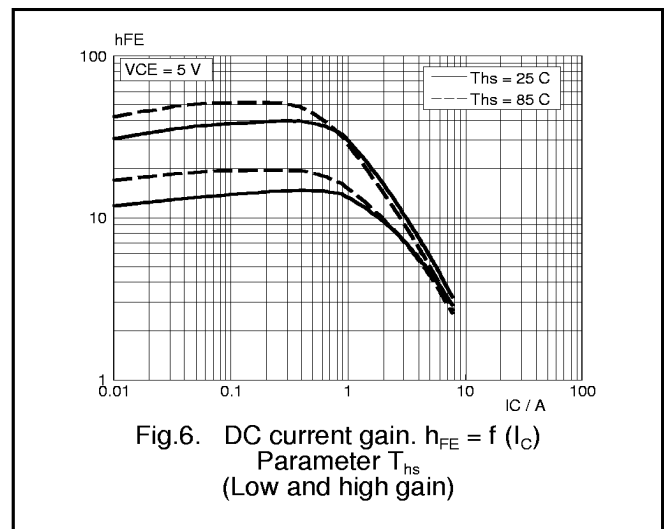
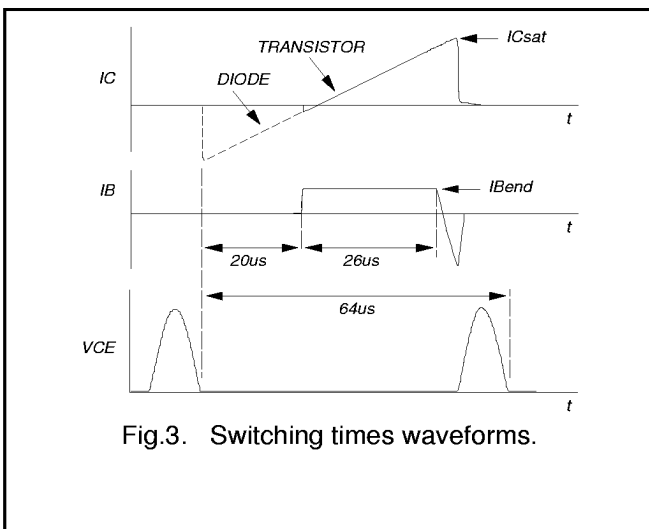
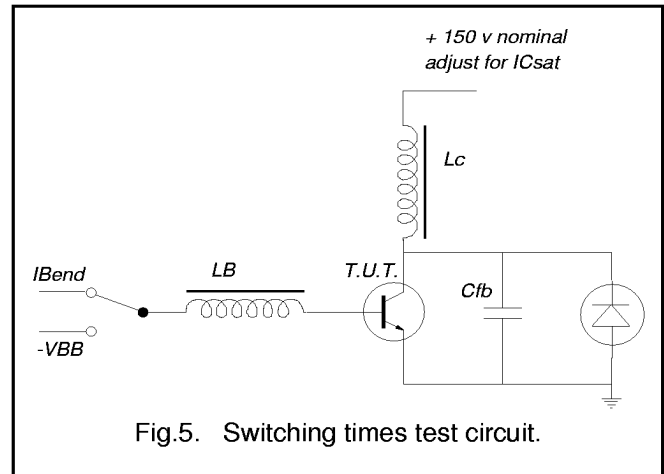
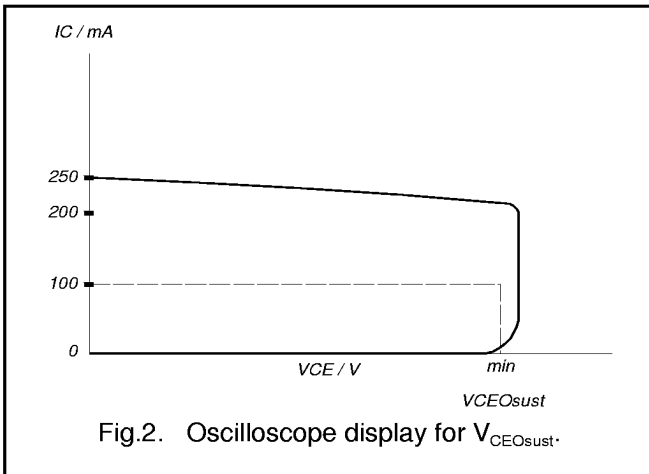
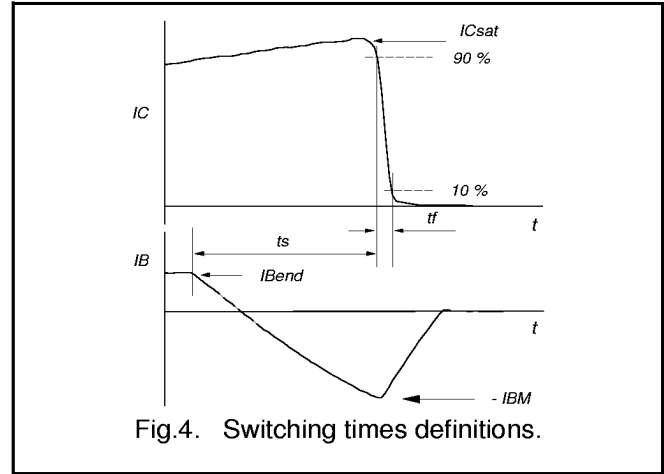
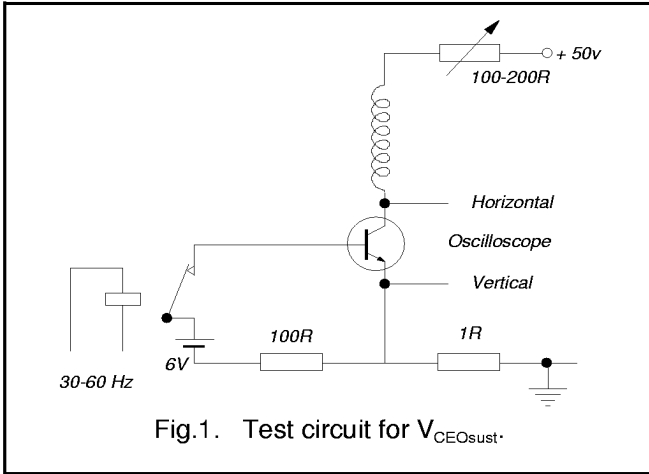
 $T_{hs} = 25\text{ °C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
	Switching times (line deflection circuit 16 kHz)	$I_{Csat} = 4\text{ A}; I_{B(end)} = 0.8\text{ A}; -I_{BM} = I_{CM}/2;$ $L_B = 6\text{ }\mu\text{H}; -V_{BB} = 4\text{ V}; L_C = 1\text{ mH};$ $C_{FB} = 12.2\text{ nF}$			
t_s	Turn-off storage time		4.8	5.5	μs
t_f	Turn-off fall time		0.4	0.52	μs

² Measured with half sine-wave voltage (curve tracer).

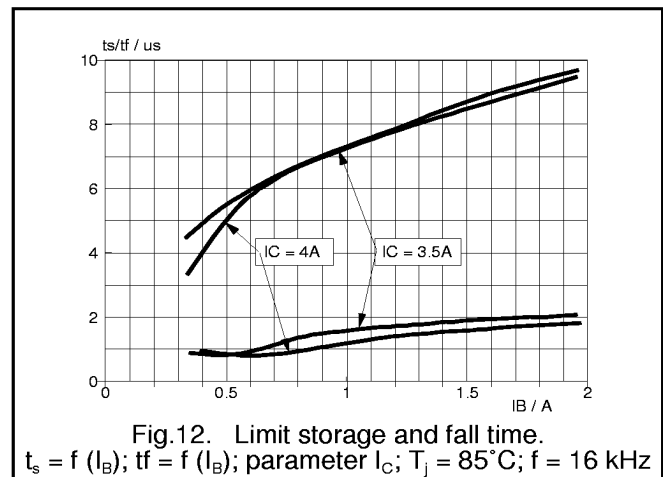
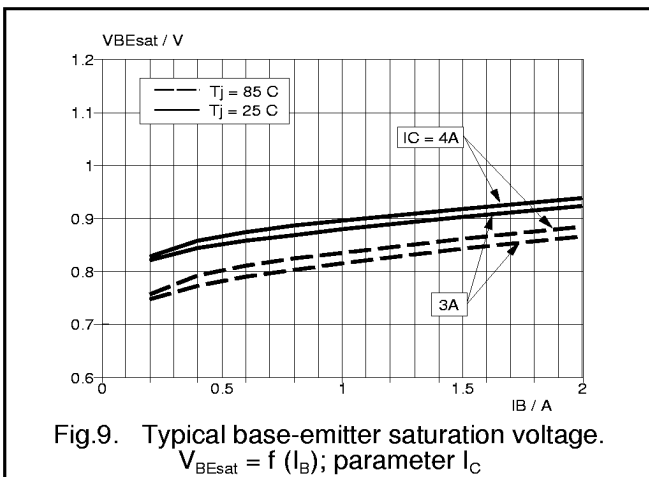
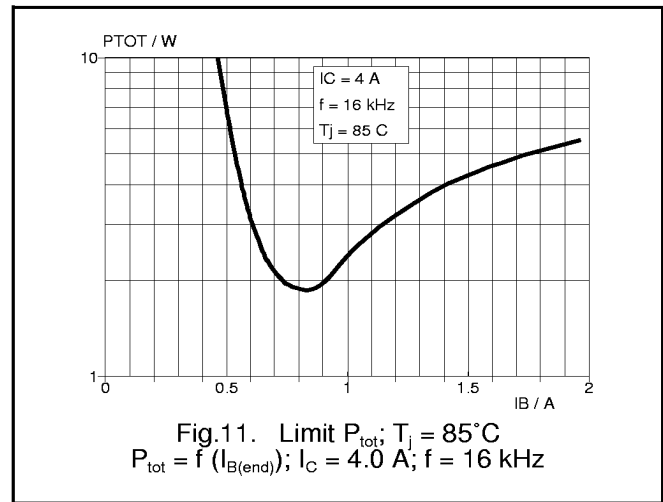
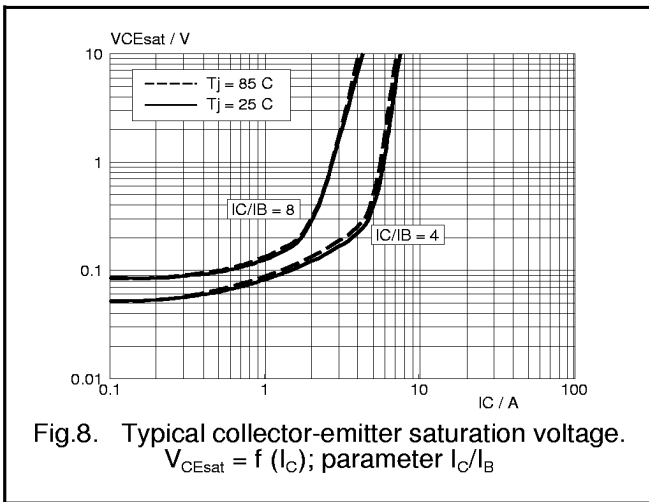
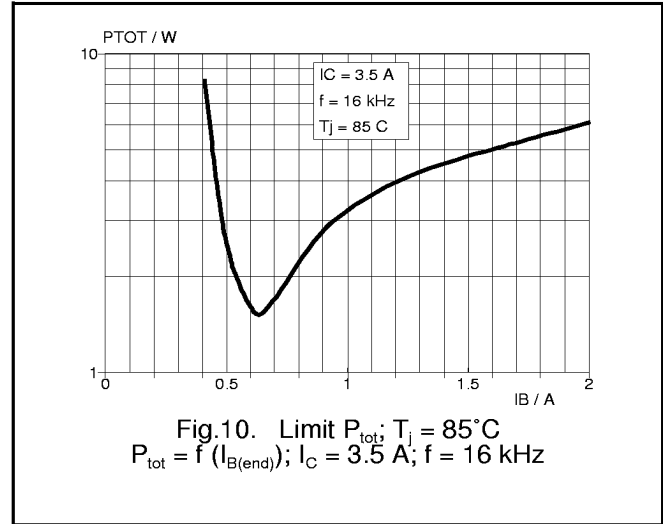
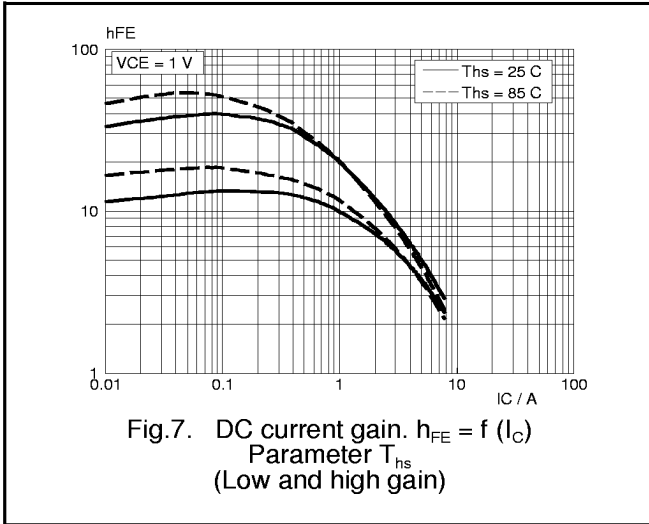
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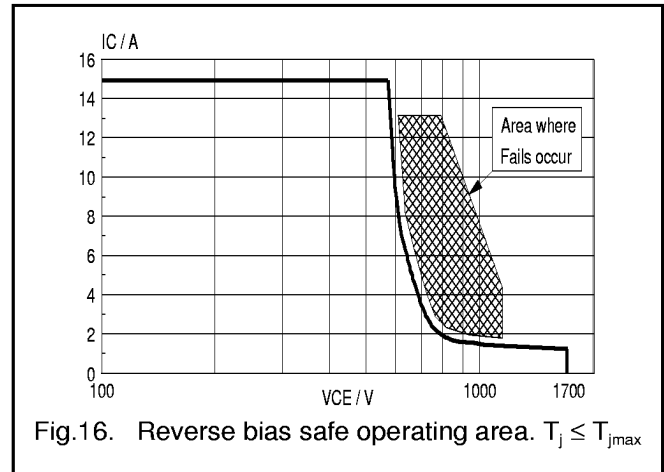
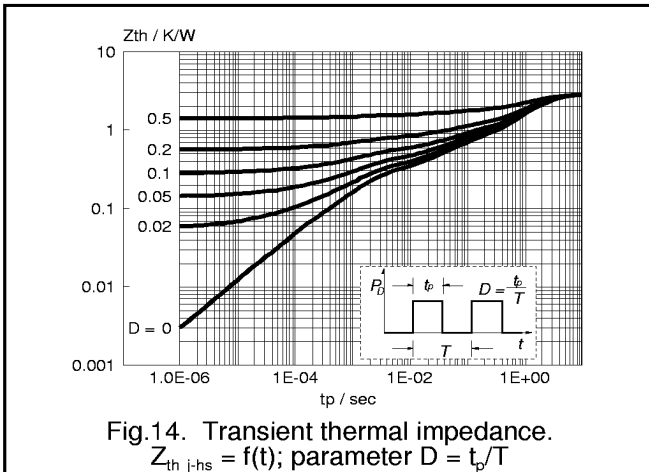
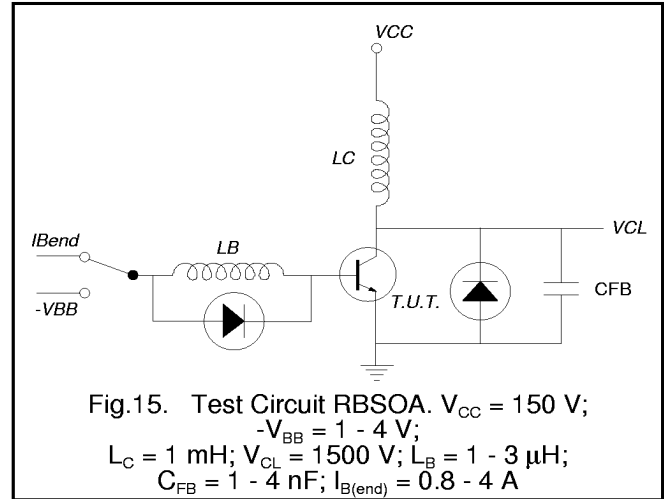
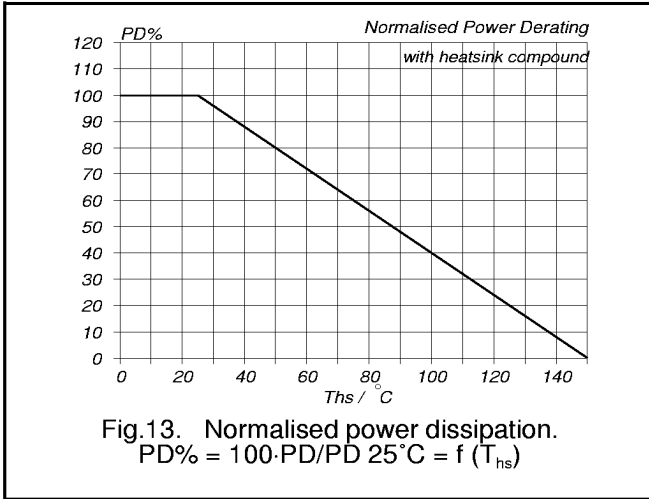
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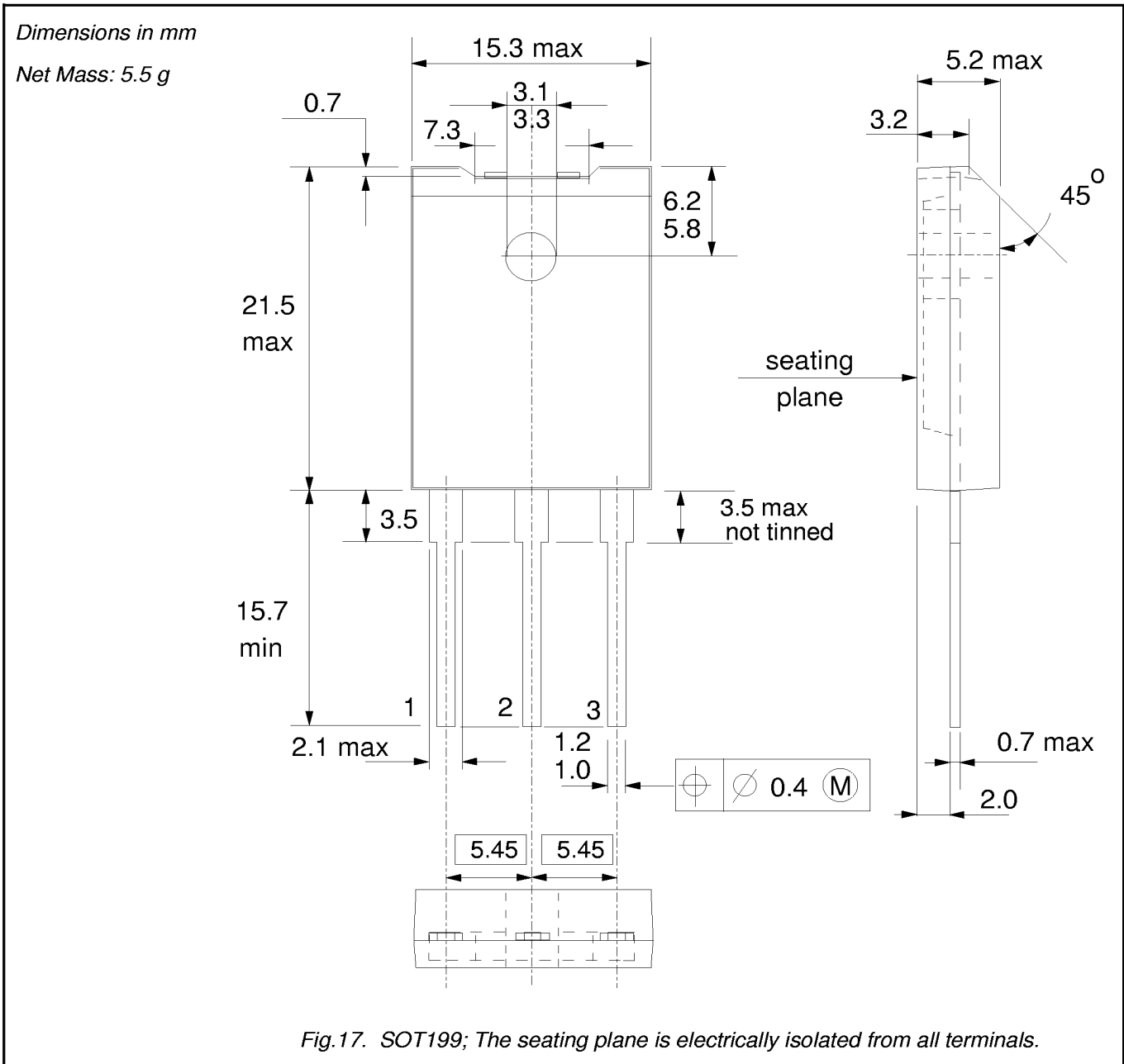
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MECHANICAL DATA



Notes

1. Refer to mounting instructions for F-pack envelopes.
2. Epoxy meets UL94 V0 at 1/8".